

2A, 200V - 1000V Standard Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Freewheeling
- Snubber
- DC/DC converters
- Automotive application

MECHANICAL DATA

- Case: Thin SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.029g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
١ _F	2	А	
V _{RRM}	200 - 1000	V	
I _{FSM}	50	А	
T _{J MAX}	150	°C	
Package	Thin SMA		
Configuration	Single die		



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)								
PARAMETER		SYMBOL	S2D Alh	S2G ALH	S2J Alh	S2K Alh	S2M Alh	UNIT
Marking code on the device			S2DAH	S2GAH	S2JAH	S2KAH	S2MAH	
Repetitive peak reverse voltage		V _{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value		V _{R(RMS)}	140	280	420	560	700	V
Forward current		I _F			2			Α
Surge peak forward current, single half sine-wave superimposed on rated load	t = 8.3ms		50				Α	
	t = 1.0ms	I _{FSM}			140			Α
Junction temperature		TJ	-55 to +150					°C
Storage temperature		T _{STG}	-55 to +150				°C	



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THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	UNIT	
Junction-to-lead thermal resistance	R _{ejl}	14	°C/W	
Junction-to-ambient thermal resistance	R _{eja}	74	°C/W	
Junction-to-case thermal resistance	R _{eJC}	20	°C/W	

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 1A, T_J = 25^{\circ}C$		0.91	-	V
	$I_F = 2A, T_J = 25^{\circ}C$	V _F	0.98	1.10	V
	I _F = 1A, T _J = 125°C		0.79	-	V
	$I_F = 2A, T_J = 125^{\circ}C$		0.88	0.98	V
Reverse current @ rated V _R ⁽²⁾	$T_J = 25^{\circ}C$	- I _R	-	1	μA
Reverse current @ rated v _R	T _J = 125°C		-	33	μA
Junction capacitance	1MHz, V _R = 4.0V	CJ	12	-	pF

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING		
S2xALH	Thin SMA	14,000 / Tape & Reel		

Notes:

1. "x" defines voltage from 200V(S2DALH) to 1000V(S2MALH)



f=1.0MHz Vsig=50mVp-p

100

CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$



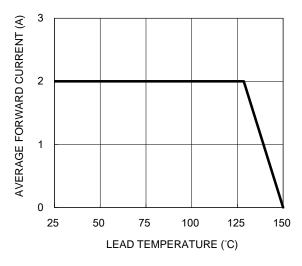
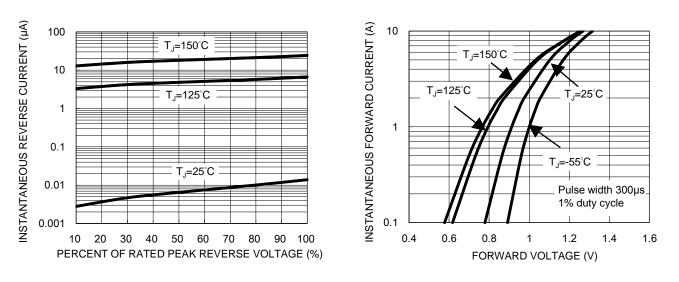


Fig.3 Typical Reverse Characteristics



100

10

1

1

CAPACITANCE (pF)

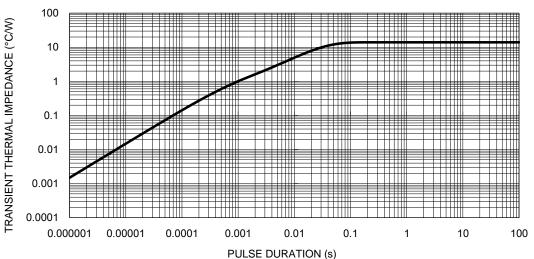


Fig.5 Typical Transient Thermal Impedance

Fig.2 Typical Junction Capacitance

10

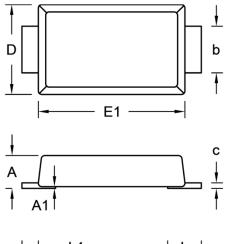
REVERSE VOLTAGE (V)

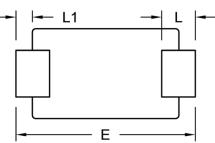
Fig.4 Typical Forward Characteristics



PACKAGE OUTLINE DIMENSIONS

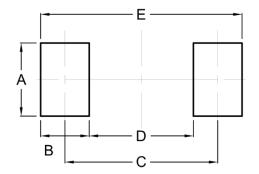
Thin SMA





DIM.	Unit	Unit (mm)		(inch)
	Min.	Max.	Min.	Max.
A	0.90	1.00	0.035	0.039
A1	0.00	0.10	0.000	0.004
b	1.25	1.45	0.049	0.057
с	0.10	0.22	0.004	0.009
D	2.50	2.70	0.098	0.106
E	5.05	5.35	0.199	0.211
E1	4.15	4.35	0.163	0.171
L	0.75	1.20	0.030	0.047
L1	0.30	0.60	0.012	0.024

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	2.10	0.083
В	1.40	0.055
С	4.40	0.173
D	3.00	0.118
E	5.80	0.228

MARKING DIAGRAM



P/N	= Marking Code
YW	= Date Code
F	= Factory Code



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